

NUF8402MN

8 Line EMI Filter with ESD Protection

This device is an 8 line EMI filter array for wireless applications. Greater than -35 dB attenuation is obtained at frequencies from 800 MHz to 2.2 GHz. It also offers ESD protection—clamping transients from static discharges. ESD protection is provided across all capacitors.

Features

- EMI Filtering and ESD Protection
- Integration of 24 Discrete Components
- Compliance with IEC61000-4-2 (Level 4)
> 18 kV (Contact)
- DFN Package, 1.6 x 4.0 mm
- Moisture Sensitivity Level 1
- ESD Ratings: Human Body Model = 3B
Machine Model = C
- This is a Pb-Free Device*

Benefits

- Reduces EMI/RFI Emissions on a Data Line
- Integrated Solution Offers Cost and Space Savings
- Reduces Parasitic Inductances Which Offer a More “Ideal” Low Pass Filter Response
- Integrated Solution Improves System Reliability

Applications

- EMI Filtering and ESD Protection for Data Lines
- Wireless Phones
- Handheld Products
- Notebook Computers
- LCD Displays

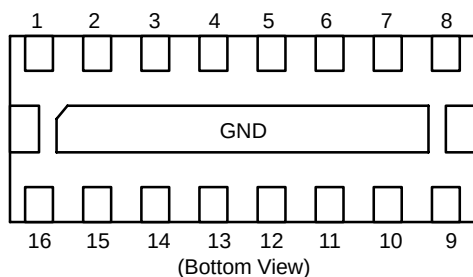


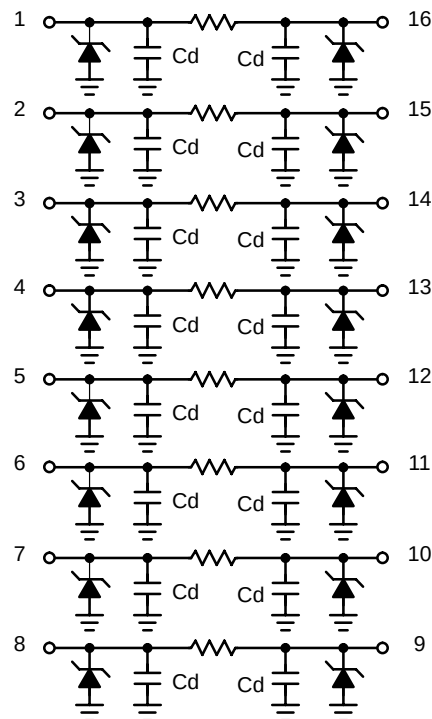
Figure 1. Pin Connections

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



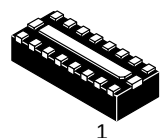
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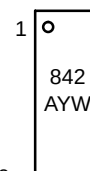


(Top View)

MARKING DIAGRAM



DFN
CASE 506AC



842 = Specific Device Code
A = Assembly Location
Y = Year
W = Work Week

ORDERING INFORMATION

Device	Package	Shipping†
NUF8402MNT4G	DFN16 (Pb-Free)	4000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
ESD Discharge IEC61000-4-2 Contact Discharge	V_{PP}	18	kV
Operating Temperature Range	T_{OP}	-40 to 85	°C
Storage Temperature Range	T_{STG}	-55 to 150	°C
Maximum Lead Temperature for Soldering Purposes (1.8 in from case for 10 seconds)	T_L	260	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Maximum Reverse Working Voltage	V_{RWM}				5.0	V
Breakdown Voltage	V_{BR}	$I_R = 1.0 \text{ mA}$	6.0	7.0	8.0	V
Leakage Current	I_R	$V_{RWM} = 3.3 \text{ V}$			100	nA
Resistance	R_A	$I_R = 20 \text{ mA}$	85	100	115	Ω
Capacitance (Notes 1 and 2)	C_d		15	17	20	pF
Cut-Off Frequency (Note 3)	f_{3dB}	Above this frequency, appreciable attenuation occurs		105		MHz

1. Measured at 25°C , $V_R = 2.5 \text{ V}$, $f = 1.0 \text{ MHz}$.
2. Total Line Capacitance is 2 times the Diode Capacitance (C_d).
3. 50Ω source and 50Ω load termination.

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TYPICAL PERFORMANCE CURVES ($T_A = 25^\circ\text{C}$ unless otherwise specified)

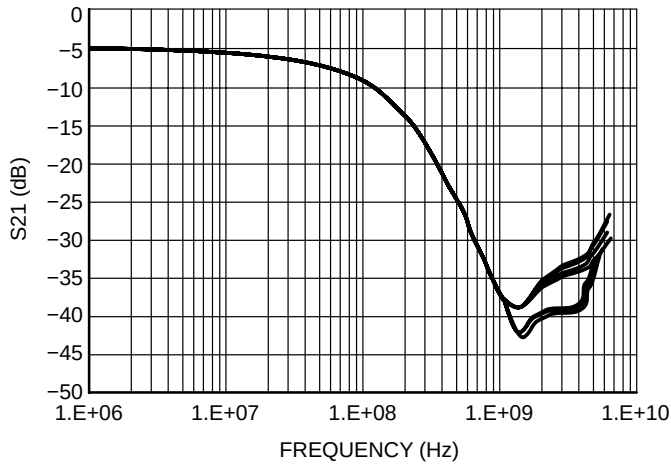


Figure 2. Insertion Loss Characteristic
(S21 Measurement)

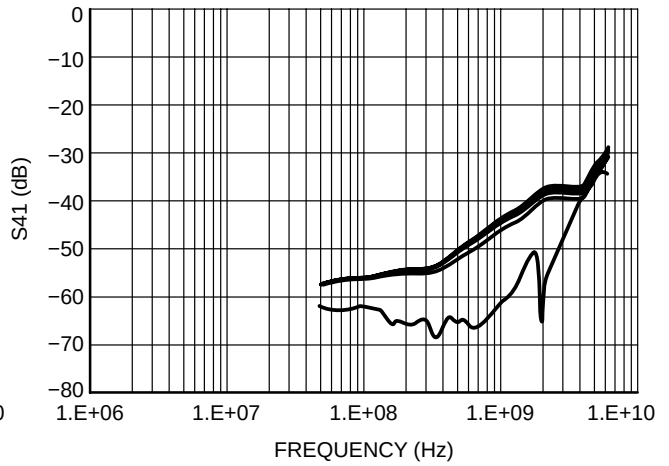


Figure 3. Analog Crosstalk Curve
(S41 Measurement)

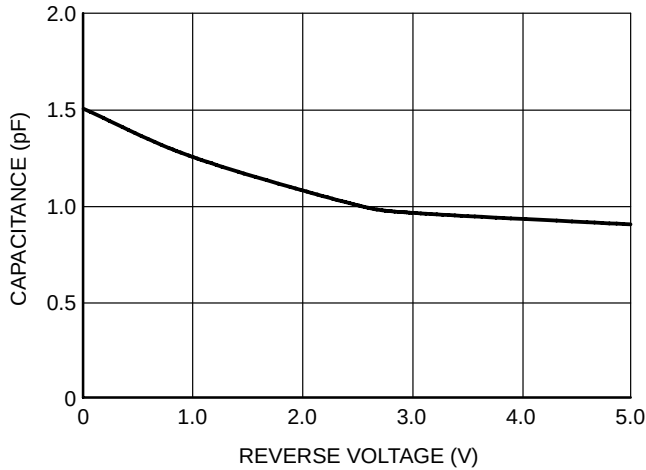


Figure 4. Typical Capacitance vs. Reverse Biased Voltage
(Normalized Capacitance C_d at 2.5 V)

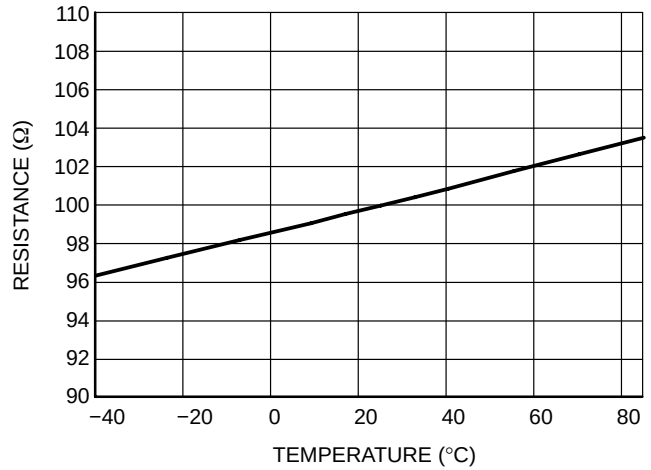


Figure 5. Typical Resistance over Temperature

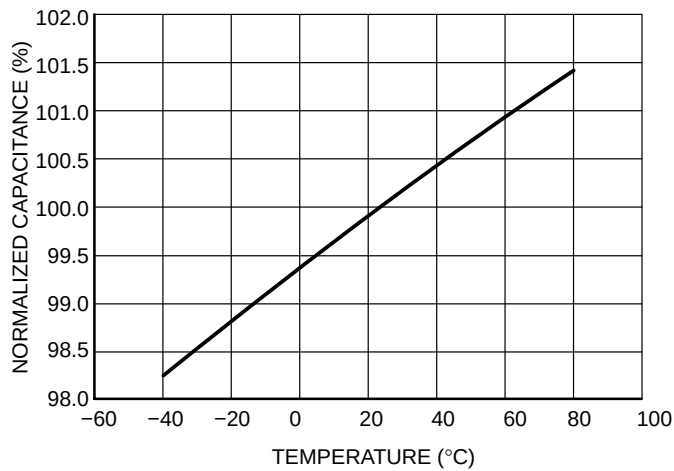
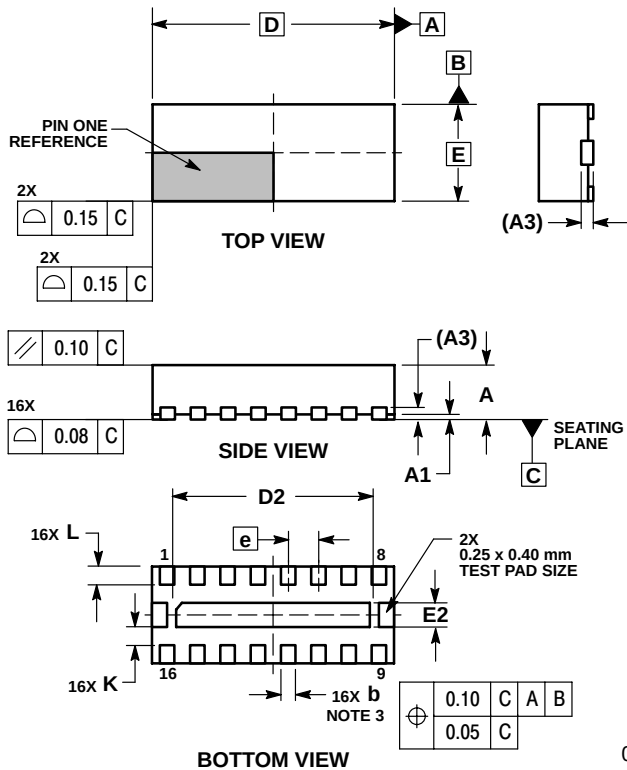


Figure 6. Normalized Capacitance over Temperature
(Normalized @ 25°C , $V_R = 2.5\text{ V}$, $f = 1\text{ MHz}$)

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PACKAGE DIMENSIONS

DFN16
CASE 506AC-01
ISSUE B

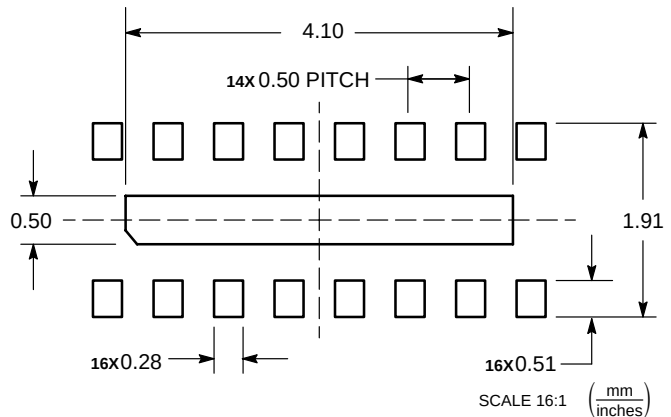


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION b APPLIES TO TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.20	REF
b	0.18	0.30
D	4.00	BSC
D2	3.10	3.30
E	1.60	BSC
E2	0.30	0.50
e	0.50	BSC
K	0.20	---
L	0.20	0.40

SOLDERING FOOTPRINT*



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NUF8402MN/D



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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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